

Film Capacitors

Capacitors for RFI Filtering, Smoothing, General-Purpose

Series/Type: B3262*A/J

Date: June 2026

© TDK Electronics AG 2026. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without TDK Electronics' prior express consent is prohibited.

High pulse (stacked)
Typical applications

- Compact fluorescent lamps (CFL)
- SMPS

Climatic

- Max. operating temperature: 105 °C
- Climatic category (IEC 60068-1:2013): 55/100/56

Construction

- Dielectric: polypropylene (PP)
- Stacked-film technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

Features

- Very high pulse strength
- Very good self-healing properties
- Smallest possible dimensions
- High contact reliability
- RoHS-compatible

Terminals

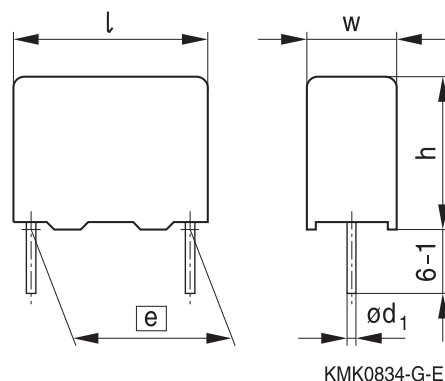
- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking

Manufacturer's logo,
 rated capacitance (coded),
 cap. tolerance (code letter), rated voltage,
 date of manufacture (coded),
 for lead spacing 7.5 mm: style (MKP),
 for lead spacing 10 mm: lot number, series number (621)

Delivery mode

Bulk (untaped)
 Taped (Ammo pack or reel)
 For notes on taping, refer to chapter "Taping and packing".

Dimensional drawing


Dimensions in mm

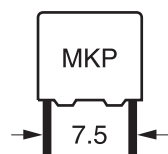
Lead spacing	Lead diameter	Type
$e \pm 0.4$	$d_1 \pm 0.05$	
7.5	0.5	B32620
10.0	0.6 ¹⁾	B32621

1) 0.5 mm for capacitor width $w = 4$ mm



Overview of available types

Lead spacing	7.5 mm						10.0 mm				
Type	B32620						B32621				
Page	4						6				
V_R (V DC)	160	250	400	630	1000	1000	160	250	400	630	1000
V_{RMS} (V AC)	90	140	200	400	500	600	90	140	200	400	500
C_R (nF)											
1.0											
1.5											
2.2											
3.3											
4.7											
6.8											
10											
15											
22											
33											
47											
68											
100											
150											
220											


B32620
High pulse (stacked)
Ordering codes and packing units (lead spacing 7.5 mm)

V_R	V_{RMS} $f \leq 1 \text{ kHz}$	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
V DC	V AC	nF					
160	90	33	$4.0 \times 8.5 \times 10.0$	B32620A5333+***	16000	14400	12000
		47	$4.0 \times 8.5 \times 10.0$	B32620A5473+***	16000	14400	12000
		68	$5.0 \times 10.5 \times 10.0$	B32620A5683+***	12800	11200	8000
		100	$5.0 \times 10.5 \times 10.0$	B32620A5104+***	12800	11200	8000
		150	$6.0 \times 12.0 \times 10.3$	B32620A5154+***	10400	8800	6000
250	140	22	$4.0 \times 8.5 \times 10.0$	B32620A3223+***	16000	14400	12000
		33	$4.0 \times 8.5 \times 10.0$	B32620A3333+***	16000	14400	12000
		47	$5.0 \times 10.5 \times 10.0$	B32620A3473+***	12800	11200	8000
		68	$5.0 \times 10.5 \times 10.0$	B32620A3683+***	12800	11200	8000
		100	$6.0 \times 12.0 \times 10.3$	B32620A3104+***	10400	8800	6000
400	200	6.8	$4.0 \times 8.5 \times 10.0$	B32620A4682+***	16000	14400	12000
		10	$4.0 \times 8.5 \times 10.0$	B32620A4103+***	16000	14400	12000
		15	$5.0 \times 10.5 \times 10.0$	B32620A4153+***	12800	11200	8000
		22	$5.0 \times 10.5 \times 10.0$	B32620A4223+***	12800	11200	8000
		33	$6.0 \times 12.0 \times 10.3$	B32620A4333+***	10400	8800	6000
630	400	1.5	$4.0 \times 8.5 \times 10.0$	B32620A6152+***	16000	14400	12000
		2.2	$4.0 \times 8.5 \times 10.0$	B32620A6222+***	16000	14400	12000
		3.3	$4.0 \times 8.5 \times 10.0$	B32620A6332+***	16000	14400	12000
		4.7	$4.0 \times 8.5 \times 10.0$	B32620A6472+***	16000	14400	12000
		6.8	$5.0 \times 10.5 \times 10.0$	B32620A6682+***	12800	11200	8000
		10	$5.0 \times 10.5 \times 10.0$	B32620A6103+***	12800	11200	8000
		15	$6.0 \times 12.0 \times 10.3$	B32620A6153+***	10400	8800	6000

MOQ = Minimum Order Quantity, consisting of 8 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$

*** = Packaging code:

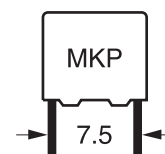
289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

000 = Straight terminals, Untaped (standard lead length 6 – 1 mm)

B32620

High pulse (stacked)



Ordering codes and packing units (lead spacing 7.5 mm)

V_R	V_{RMS} $f \leq 1 \text{ kHz}$	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
V DC	V AC	nF					
1000	500	1.5	$4.0 \times 8.5 \times 10.0$	B32620A0152+***	16000	14400	12000
		2.2	$4.0 \times 8.5 \times 10.0$	B32620A0222+***	16000	14400	12000
		3.3	$5.0 \times 10.5 \times 10.0$	B32620A0332+***	12800	11200	8000
		4.7	$5.0 \times 10.5 \times 10.0$	B32620A0472+***	12800	11200	8000
		6.8	$6.0 \times 12.0 \times 10.3$	B32620A0682+***	10400	8800	6000
1000	600	1.0	$5.0 \times 10.5 \times 10.0$	B32620J0102+***	12800	11200	8000
		1.5	$5.0 \times 10.5 \times 10.0$	B32620J0152+***	12800	11200	8000
		2.2	$5.0 \times 10.5 \times 10.0$	B32620J0222+***	12800	11200	8000
		3.3	$5.0 \times 10.5 \times 10.0$	B32620J0332+***	12800	11200	8000
		4.7	$6.0 \times 12.0 \times 10.3$	B32620J0472+***	10400	8800	6000

MOQ = Minimum Order Quantity, consisting of 8 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

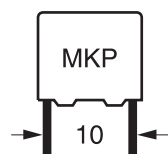
J = $\pm 5\%$

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

000 = Straight terminals, Untaped (standard lead length 6 – 1 mm)


B32621
High pulse (stacked)
Ordering codes and packing units (lead spacing 10 mm)

V_R	V_{RMS} $f \leq 1 \text{ kHz}$	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
V DC	V AC	nF					
160	90	47	$4.0 \times 7.0 \times 13.0$	B32621A5473+***	8000	13600	8000
		68	$4.0 \times 9.0 \times 13.0$	B32621A5683+***	8000	13600	8000
		100	$5.0 \times 11.0 \times 13.0$	B32621A5104+***	6640	10400	8000
		150	$5.0 \times 11.0 \times 13.0$	B32621A5154+***	6640	10400	8000
		220	$6.0 \times 12.0 \times 13.0$	B32621A5224+***	5440	8800	8000
250	140	2.2	$4.0 \times 7.0 \times 13.0$	B32621A3222+***	8000	13600	8000
		3.3	$4.0 \times 9.0 \times 13.0$	B32621A3332+***	8000	13600	8000
		4.7	$4.0 \times 9.0 \times 13.0$	B32621A3472+***	8000	13600	8000
		6.8	$4.0 \times 9.0 \times 13.0$	B32621A3682+***	8000	13600	8000
		10	$4.0 \times 9.0 \times 13.0$	B32621A3103+***	8000	13600	8000
		15	$4.0 \times 9.0 \times 13.0$	B32621A3153+***	8000	13600	8000
		22	$4.0 \times 9.0 \times 13.0$	B32621A3223+***	8000	13600	8000
		33	$4.0 \times 9.0 \times 13.0$	B32621A3333+***	8000	13600	8000
		47	$4.0 \times 9.0 \times 13.0$	B32621A3473+***	8000	13600	8000
		68	$5.0 \times 11.0 \times 13.0$	B32621A3683+***	6640	10400	8000
		100	$6.0 \times 12.0 \times 13.0$	B32621A3104+***	5440	8800	8000
400	200	10	$4.0 \times 9.0 \times 13.0$	B32621A4103+***	8000	13600	8000
		15	$4.0 \times 9.0 \times 13.0$	B32621A4153+***	8000	13600	8000
		22	$5.0 \times 11.0 \times 13.0$	B32621A4223+***	6640	10400	8000
		33	$5.0 \times 11.0 \times 13.0$	B32621A4333+***	6640	10400	8000
		47	$6.0 \times 12.0 \times 13.0$	B32621A4473+***	5440	8800	8000

MOQ = Minimum Order Quantity, consisting of 8 packing units.

Intermediate capacitances values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$

*** = Packaging code:

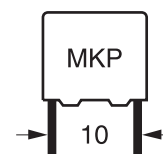
289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

000 = Straight terminals, Untaped (standard lead length 6 – 1 mm)

B32621

High pulse (stacked)



Ordering codes and packing units (lead spacing 10 mm)

V_R	V_{RMS} $f \leq 1 \text{ kHz}$	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
V DC	V AC	nF					
630	400	2.2	$4.0 \times 7.0 \times 13.0$	B32621A6222+***	8000	13600	8000
		3.3	$4.0 \times 9.0 \times 13.0$	B32621A6332+***	8000	13600	8000
		4.7	$4.0 \times 9.0 \times 13.0$	B32621A6472+***	8000	13600	8000
		6.8	$4.0 \times 9.0 \times 13.0$	B32621A6682+***	8000	13600	8000
		10	$4.0 \times 9.0 \times 13.0$	B32621A6103+***	8000	13600	8000
		15	$5.0 \times 11.0 \times 13.0$	B32621A6153+***	6640	10400	8000
		22	$6.0 \times 12.0 \times 13.0$	B32621A6223+***	5440	8800	8000
		33	$6.0 \times 12.0 \times 13.0$	B32621A6333+***	5440	8800	8000
1000	500	2.2	$4.0 \times 7.0 \times 13.0$	B32621A0222+***	8000	13600	8000
		3.3	$4.0 \times 9.0 \times 13.0$	B32621A0332+***	8000	13600	8000
		4.7	$4.0 \times 9.0 \times 13.0$	B32621A0472+***	8000	13600	8000
		6.8	$5.0 \times 11.0 \times 13.0$	B32621A0682+***	6640	10400	8000
		10	$6.0 \times 12.0 \times 13.0$	B32621A0103+***	5440	8800	8000

MOQ = Minimum Order Quantity, consisting of 8 packing units.

Intermediate capacitances values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

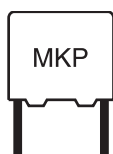
J = $\pm 5\%$

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

000 = Straight terminals, Untaped (standard lead length 6 – 1 mm)

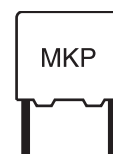


B3262*A/J

High pulse (stacked)

Technical data

Operating temperature range	Max. operating temperature T _{op,max}		+105 °C
	Upper category temperature T _{max}		+100 °C
	Lower category temperature T _{min}		−55 °C
	Rated temperature T _R		+85 °C
Dissipation factor tan δ (in 10 ^{−3}) at 20 °C (upper limit values)	at	C _R ≤ 0.1 μF	0.1 μF < C _R ≤ 0.22 μF
	1 kHz	—	1.0
	10 kHz	—	1.5
	100 kHz	4.0	—
Insulation resistance R _{ins} at 20 °C, rel. humidity ≤ 65% (minimum as-delivered values)	100 GΩ		
DC test voltage	1.6 · V _R , 2 s		
Category voltage V _C (continuous operation with V _{DC} or V _{AC} at f ≤ 1 kHz)	T _{op} (°C)	DC voltage derating	AC voltage derating
	T _{op} ≤ 85	V _C = V _R	V _{C,RMS} = V _{RMS}
	85 < T _{op} ≤ 100	V _C = V _R · (165 - T _{op})/80	V _{C,RMS} = V _{RMS} · (165 - T _{op})/80
Operating voltage V _{op} for short operating periods (V _{DC} or V _{AC} at f ≤ 1 kHz)	T _{op} (°C)	DC voltage (max. hrs.)	AC voltage (max. hrs.)
	T _{op} ≤ 85	V _{op} = 1.25 · V _C (2000 h)	V _{op} = 1.0 · V _{C,RMS} (2000 h)
	85 < T _{op} ≤ 100	V _{op} = 1.25 · V _C (1000 h)	V _{op} = 1.0 · V _{C,RMS} (1000 h)
Damp heat test	56 days/40 °C/93% relative humidity		
Limit values after damp heat test	Capacitance change ΔC/C		≤ 3%
	Dissipation factor change Δ tan δ		≤ 0.5 · 10 ^{−3} (at 1 kHz)
			≤ 1.0 · 10 ^{−3} (at 10 kHz)
	Insulation resistance R _{ins}		≥ 50% of minimum as-delivered values
Reliability:			
Failure rate λ	1 fit (≤ 1 · 10 ^{−9} /h) at 0.5 · V _R , 40 °C		
Service life t _{SL}	200 000 h at 1.0 · V _R , 85 °C		
	For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".		
Failure criteria:			
Total failure	Short circuit or open circuit		
Failure due to variation of parameters	Capacitance change ΔC/C		> ±10%
	Dissipation factor tan δ		> 4 · upper limit value
	Insulation resistance R _{ins}		< 1500 MΩ



Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/μs.

Note:

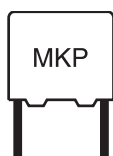
The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Lead spacing		7.5 mm	10 mm
V _R V DC	V _{RMS} V AC	dV/dt in V/μs	
160	90	750	600
250	140	1 200	900
400	200	1 500	1 050
630	400	2 700	1 800
1 000	500	3 200	2 400
1 000	600	4 000	—

k₀ values

Lead spacing		7.5 mm	10 mm
V _R V DC	V _{RMS} V AC	k ₀ in V ² /μs	
160	90	240 000	190 000
250	140	600 000	450 000
400	200	1 200 000	840 000
630	400	3 400 000	2 250 000
1 000	500	6 400 000	4 800 000
1 000	600	8 000 000	—

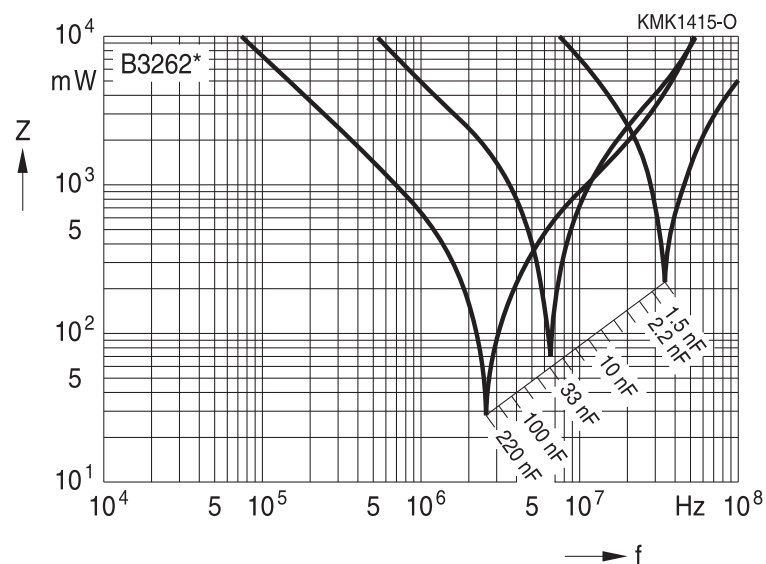


B3262*A/J

High pulse (stacked)

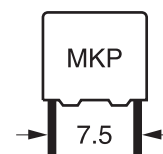
Impedance Z versus frequency f

(typical values)



B32620

High pulse (stacked)

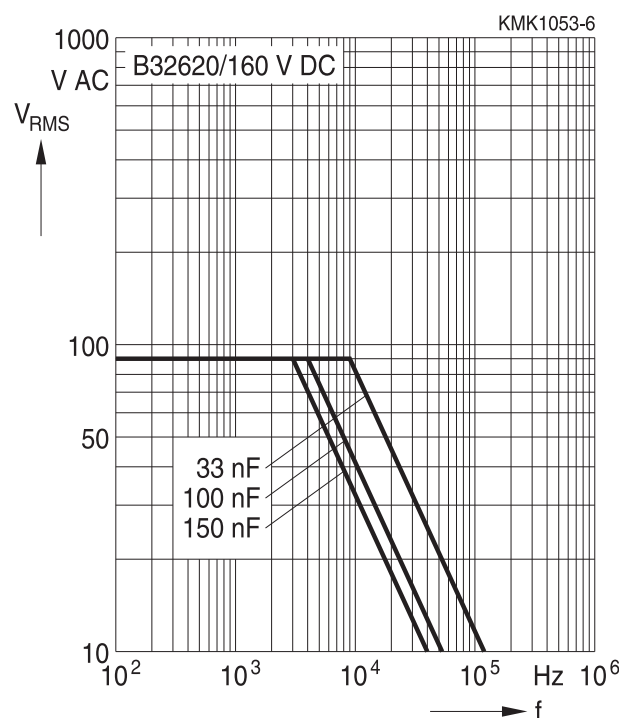


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ\text{C}$)

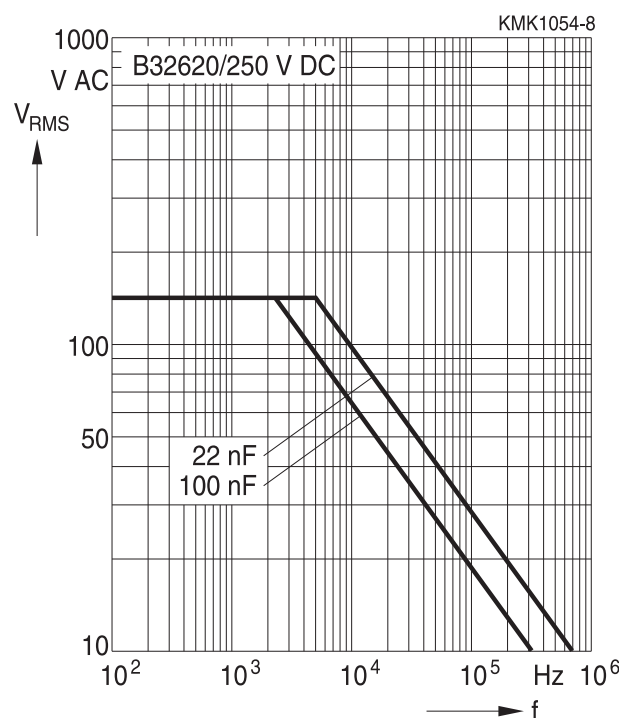
For $T_A > 90^\circ\text{C}$, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

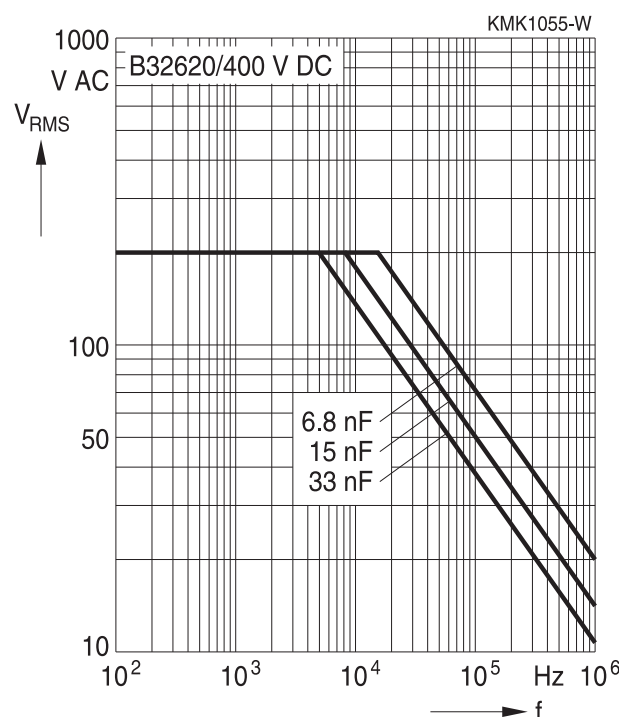
160 V DC/90 V AC



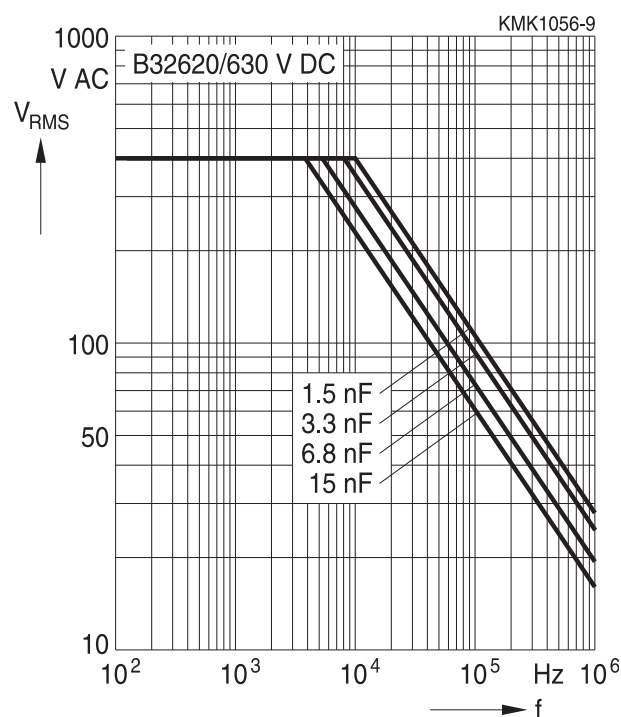
250 V DC/140 V AC

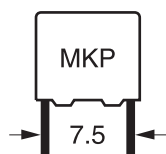


400 V DC/200 V AC



630 V DC/400 V AC





B32620

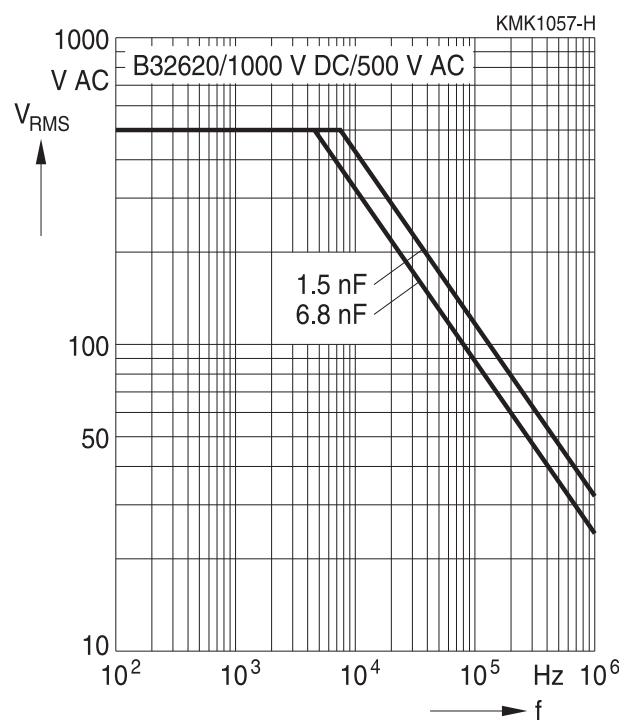
High pulse (stacked)

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ\text{C}$)

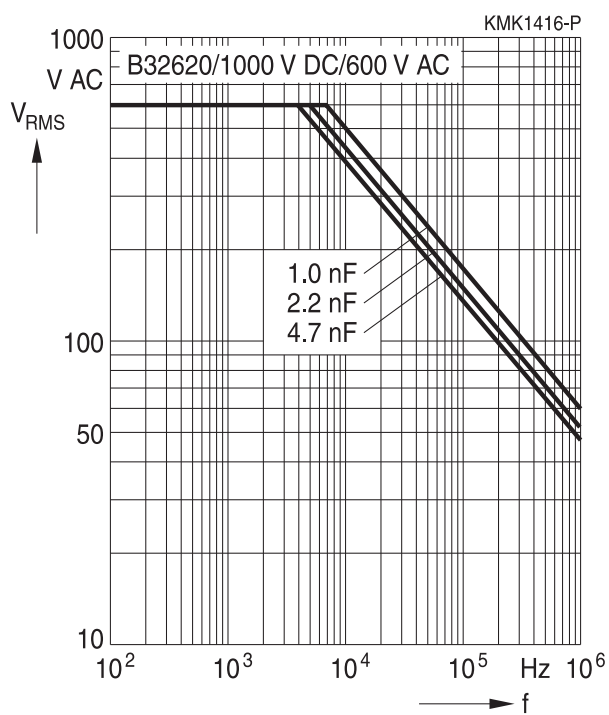
For $T_A > 90^\circ\text{C}$, please refer to "General technical information", section 3.2.3.

Lead spacing 7.5 mm

1000 V DC/500 V AC

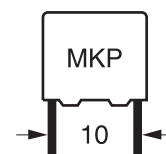


1000 V DC/600 V AC



B32621

High pulse (stacked)

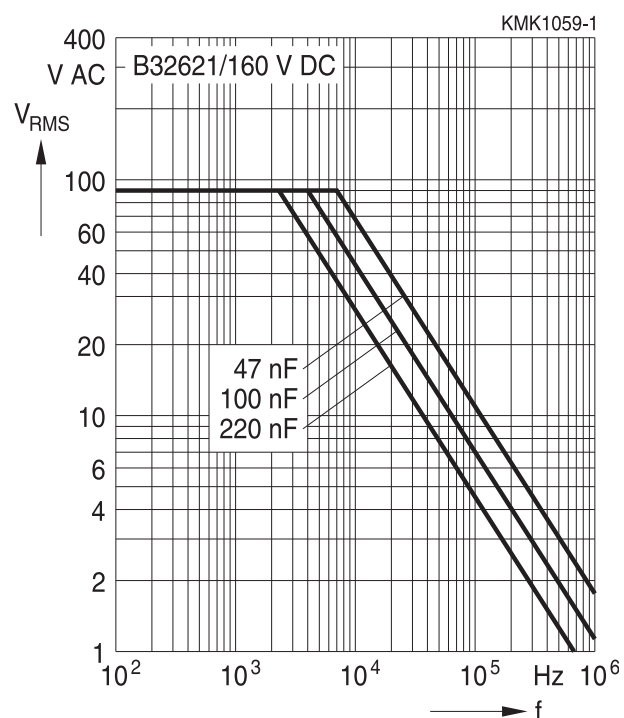


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ\text{C}$)

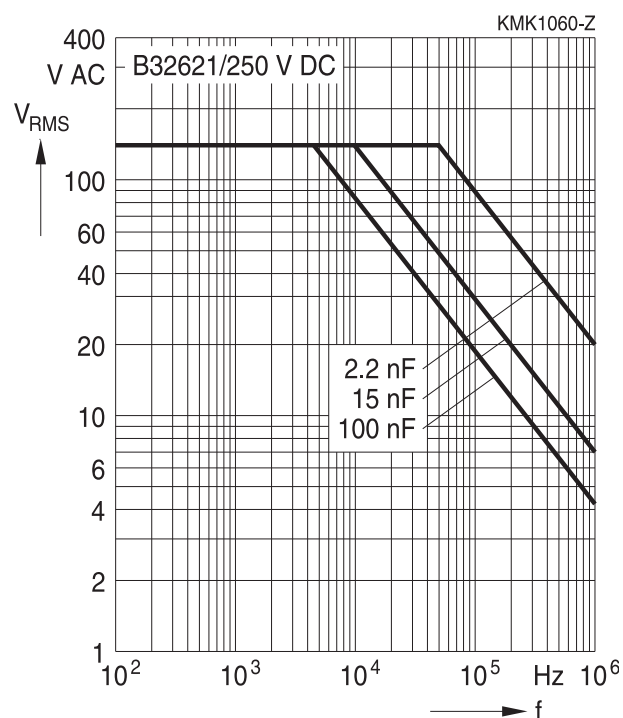
For $T_A > 90^\circ\text{C}$, please refer to "General technical information", section 3.2.3.

Lead spacing 10 mm

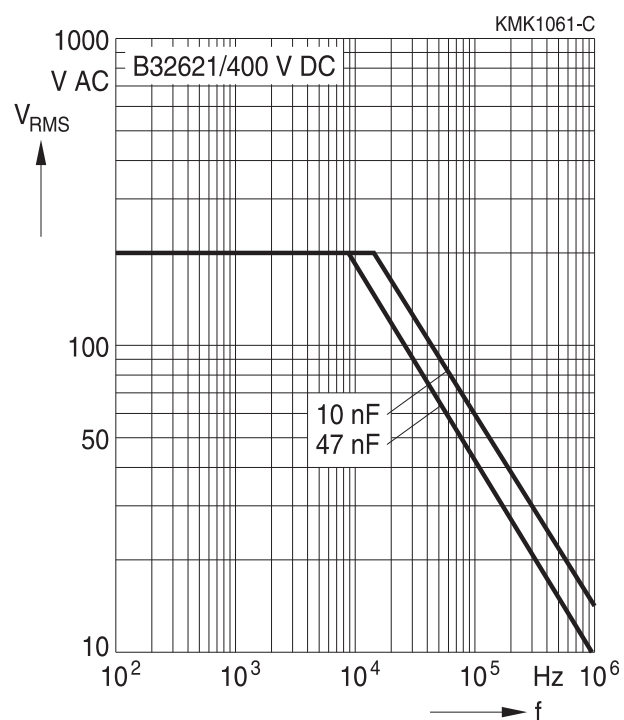
160 V DC/90 V AC



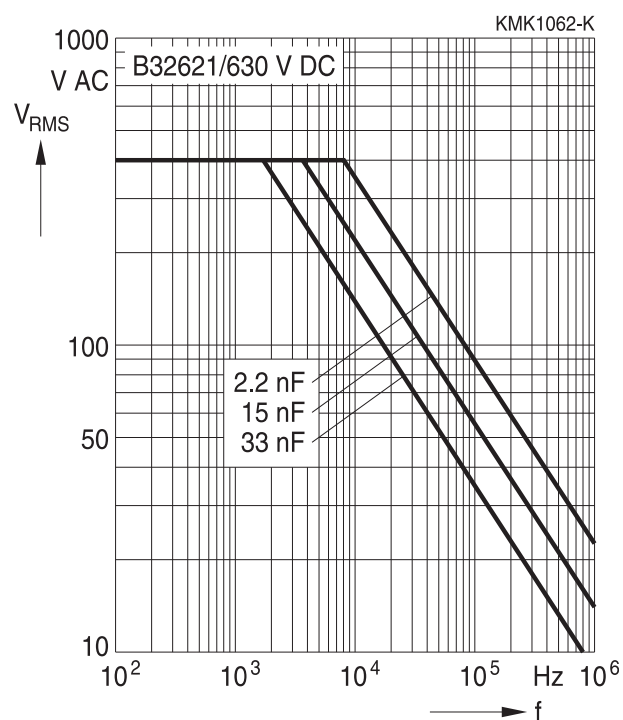
250 V DC/140 V AC

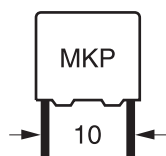


400 V DC/200 V AC



630 V DC/400 V AC





B32621

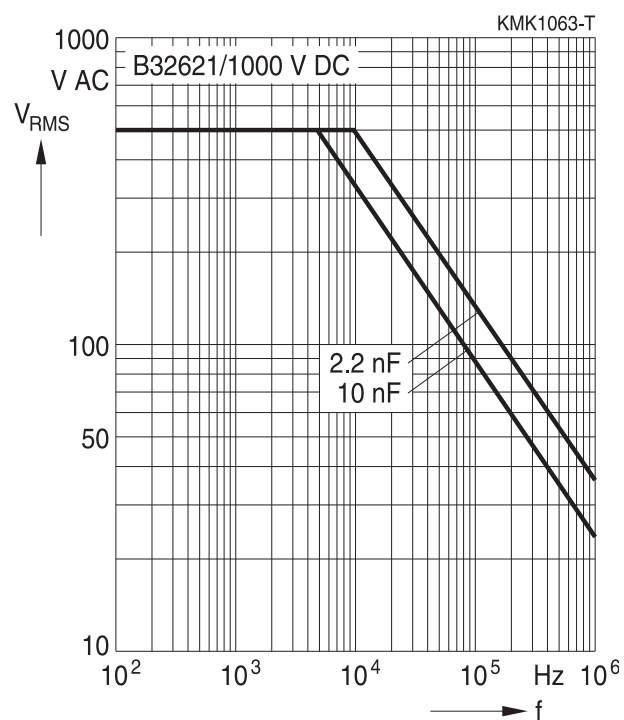
High pulse (stacked)

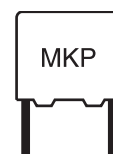
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ\text{C}$)

For $T_A > 90^\circ\text{C}$, please refer to "General technical information", section 3.2.3.

Lead spacing 10 mm

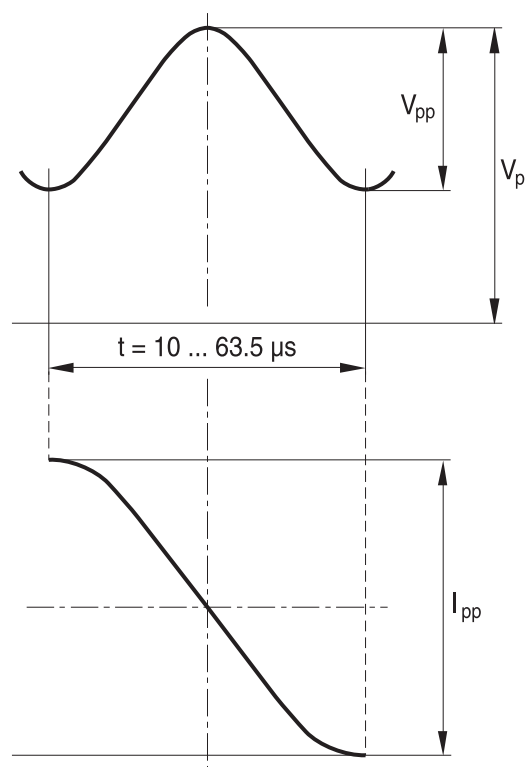
1000 V DC/500 V AC



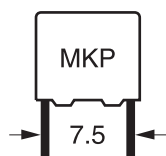


Sinus-wave application, lighting

Permissible voltage and current / waveform



KMK0721-D



B32620

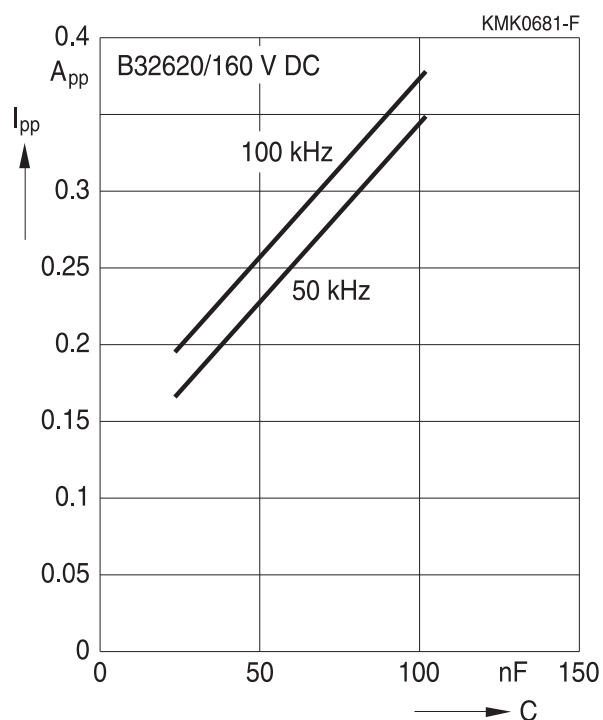
High pulse (stacked)

Sinus-wave application, lighting

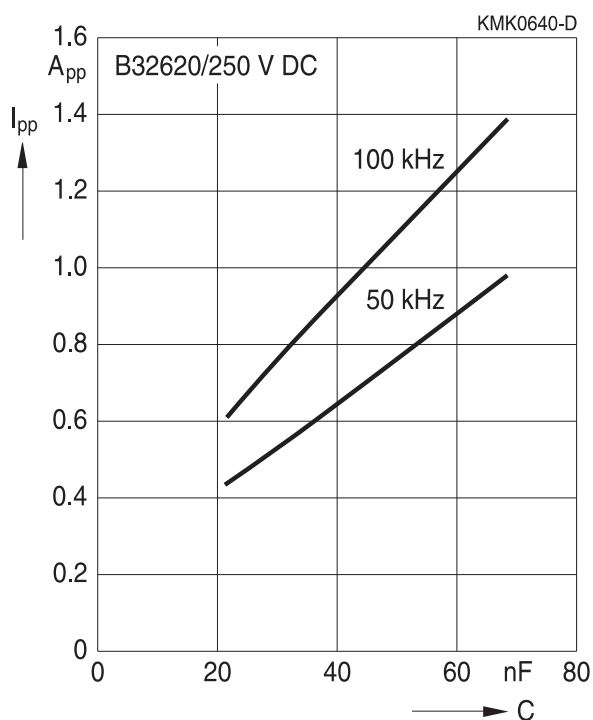
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 7.5 mm

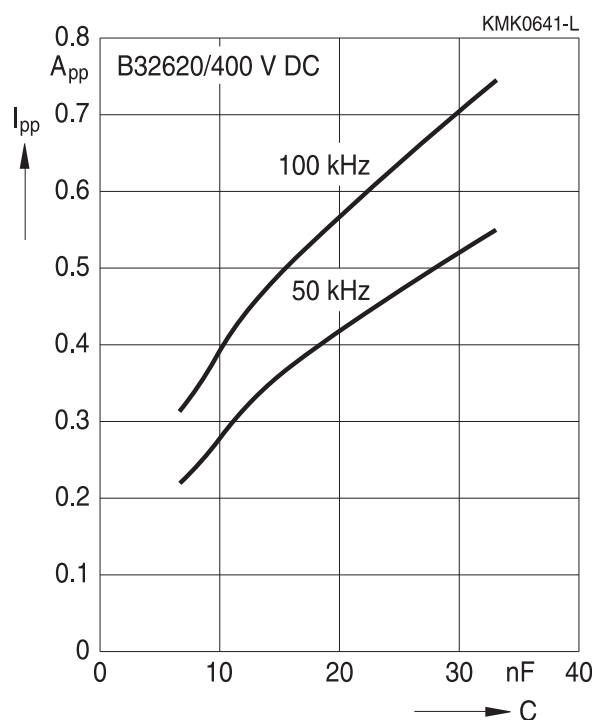
160 V DC/90 V AC



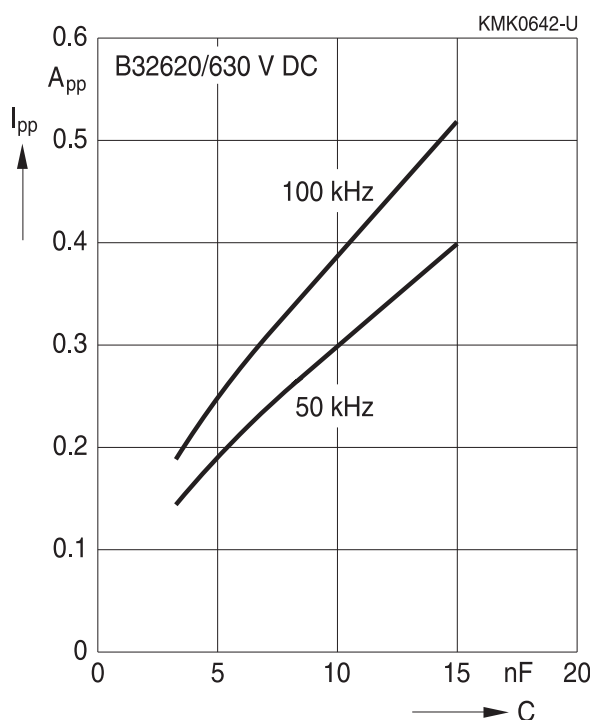
250 V DC/140 V AC



400 V DC/200 V AC

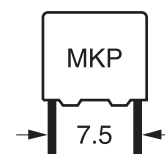


630 V DC/400 V AC



B32620

High pulse (stacked)

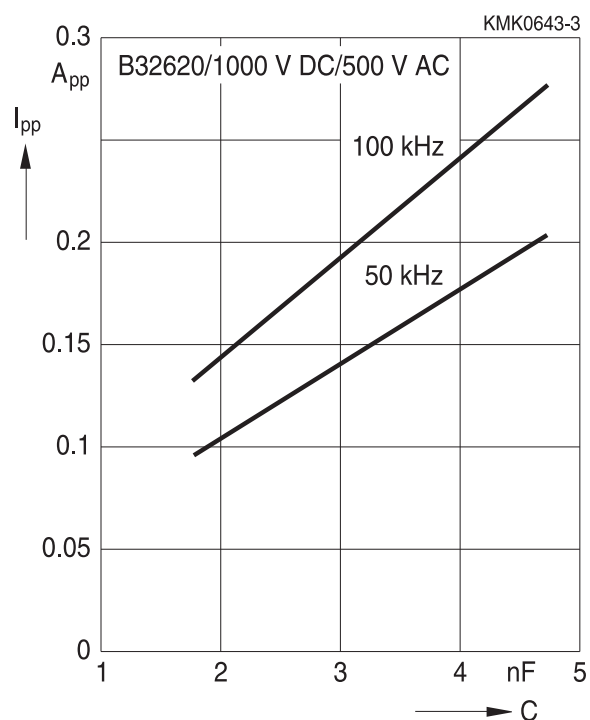


Sinus-wave application, lighting

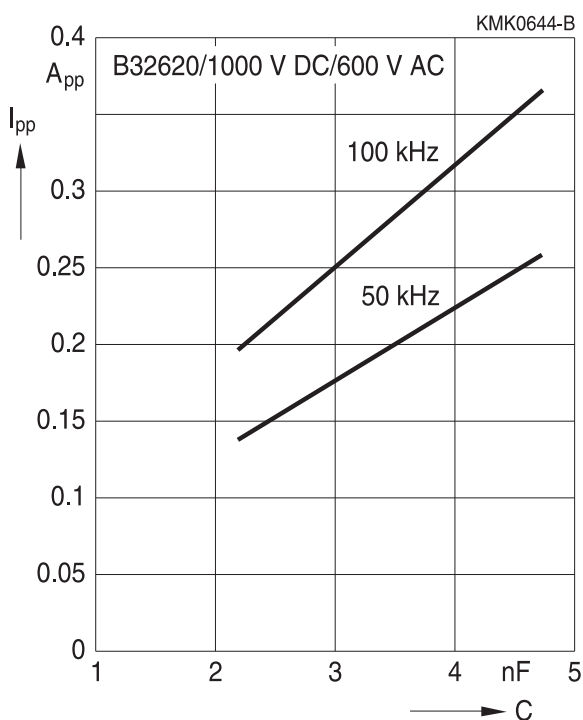
Permissible current I_{pp} versus rated capacitance C_R

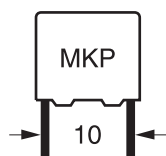
Lead spacing 7.5 mm

1000 V DC/500 V AC



1000 V DC/600 V AC





B32621

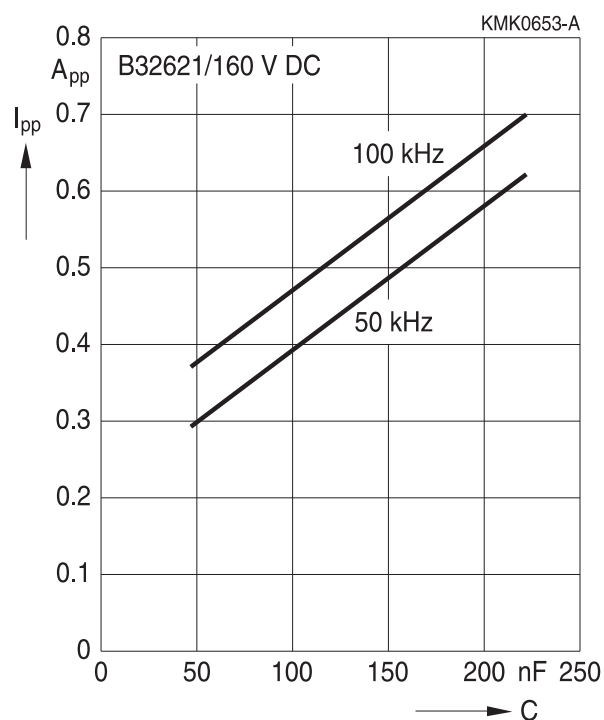
High pulse (stacked)

Sinus-wave application, lighting

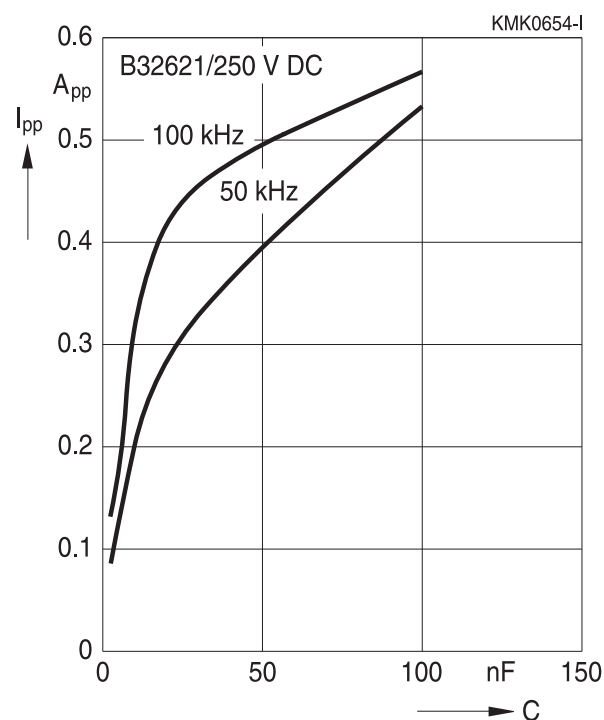
Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

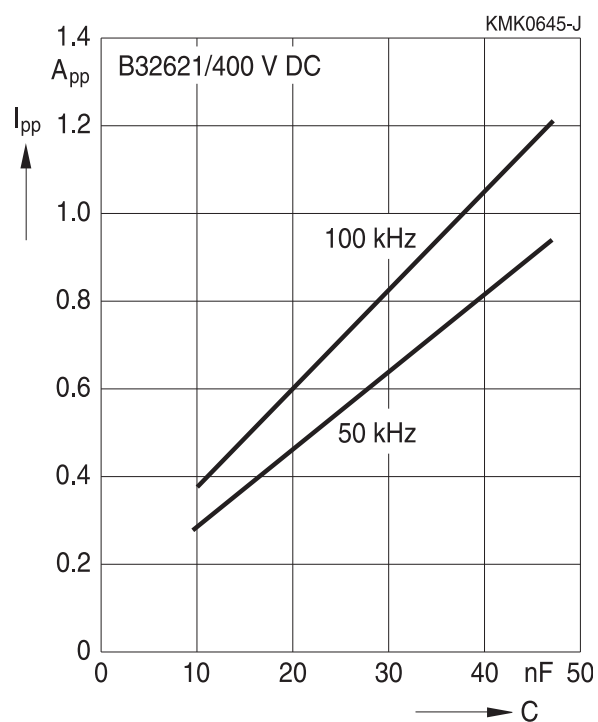
160 V DC/90 V AC



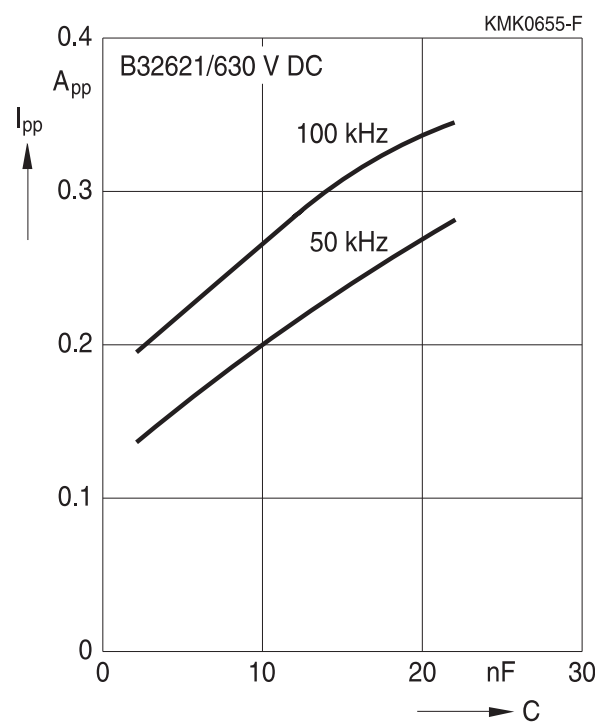
250 V DC/140 V AC



400 V DC/200 V AC

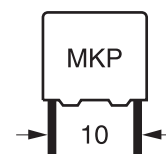


630 V DC/400 V AC



B32621

High pulse (stacked)

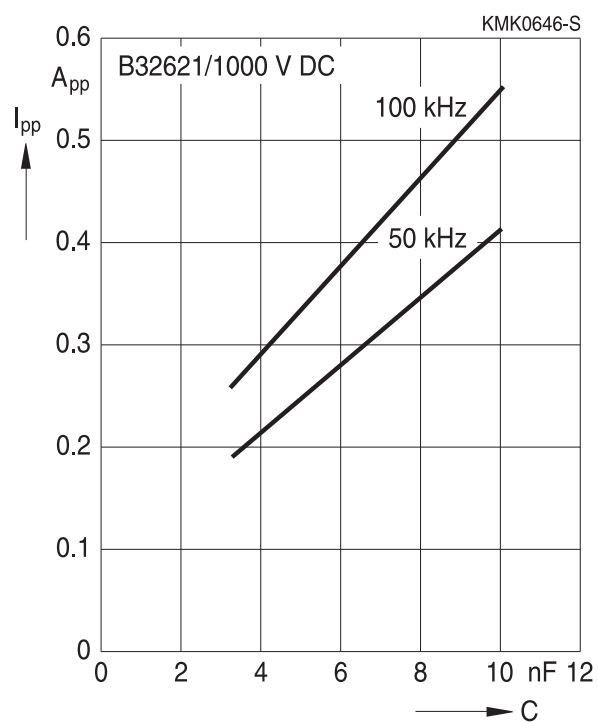


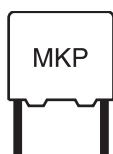
Sinus-wave application, lighting

Permissible current I_{pp} versus rated capacitance C_R

Lead spacing 10 mm

1000 V DC/500 V AC





B3262*A/J

High pulse (stacked)

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

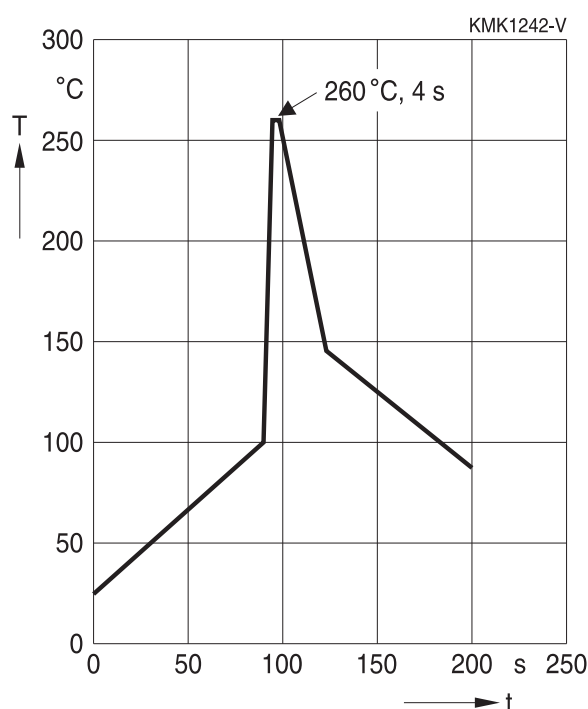
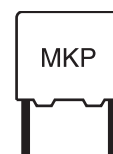
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/–0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP		
MKP (lead spacing >7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤7.5 mm)		<4 s
MKT uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)

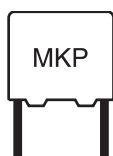


Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



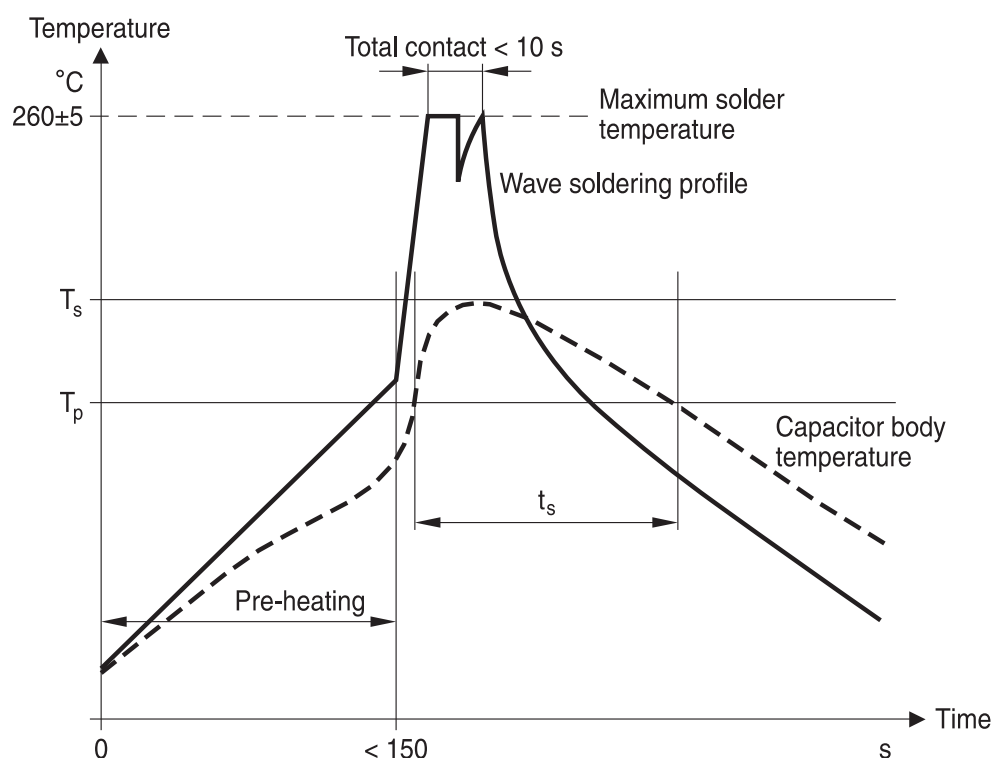
B3262*A/J

High pulse (stacked)

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

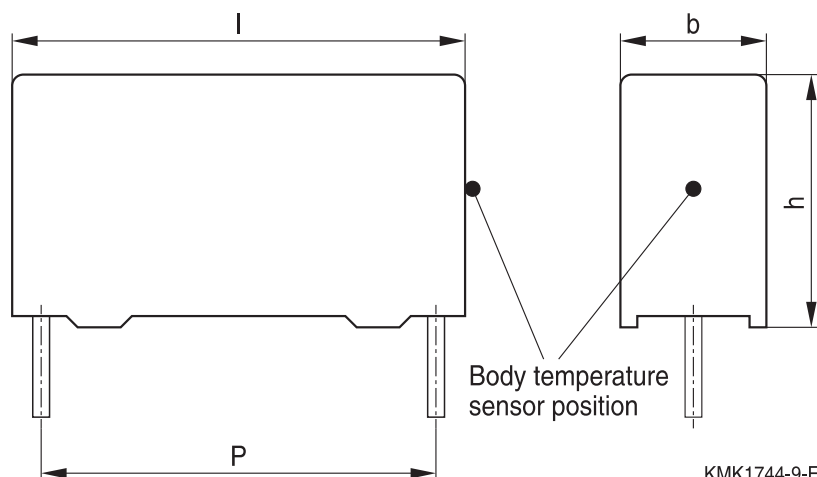
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s : Capacitor body maximum temperature at wave soldering

T_p : Capacitor body maximum temperature at pre-heating

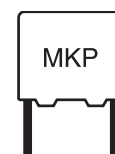
KMK1745-A-E



KMK1744-9-E

B3262*A/J

High pulse (stacked)



Body temperature should follow the description below:

- MKP capacitor
 - During pre-heating: $T_p \leq 110\text{ }^{\circ}\text{C}$
 - During soldering: $T_s \leq 120\text{ }^{\circ}\text{C}$, $t_s \leq 45\text{ s}$
- MKT capacitor
 - During pre-heating: $T_p \leq 125\text{ }^{\circ}\text{C}$
 - During soldering: $T_s \leq 160\text{ }^{\circ}\text{C}$, $t_s \leq 45\text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be $\leq 120\text{ }^{\circ}\text{C}$.

One recommended condition for manual soldering is that the tip of the soldering iron should be $< 360\text{ }^{\circ}\text{C}$ and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings $\leq 10\text{ mm}$ (B32560/B32561) the following measures are recommended:

- pre-heating to not more than $110\text{ }^{\circ}\text{C}$ in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



B3262*A/J

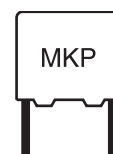
High pulse (stacked)

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

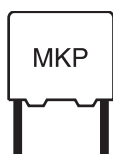
Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.

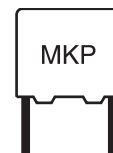


B3262*A/J

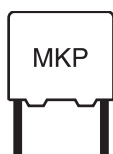
High pulse (stacked)

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature, $T_A + \Delta T$	Betriebstemperatur, $T_A + \Delta T$
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer



B3262*A/J

High pulse (stacked)

Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangsspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.

Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.** The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System.** For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2024-02